"ZERO-CROSSTALK" M83513 Micro-D VersaLink[™] Connectors



Space-Grade Outgassing Modification Codes



Is the Micro-D qualified and approved for space flight?

Yes. The connectors in this catalog are "good to go" for space flight. Zinc-nickel plated connectors should not be used for space applications. Electroless nickel is recommended.

Do Micro-D connectors meet outgassing requirements?

Connectors must be vacuum baked to guarantee compliance with outgassing limits established by NASA and military space programs. The requirements are 1.0% Total Mass Loss (TML) and 0.1% Collected Volatile Condensible Material (CVCM). ASTM E595 defines the test procedure.

What is vacuum bakeout?

Connectors are placed in a special oven for 24 hours at $+125^{\circ}$ C and a vacuum of 10^{-6} Torr.

Are Micro-D connectors non-magnetic?

Micro-D connectors meet the 2.0µ magnetic permeability requirement of EIA-364-54. Additional residual magnetism screening is available on request.

High-Speed VersaLink connector is a high density, lightweight, high performance connector ideal for space flight applications. These connectors are available with NASA-grade screening and vacuum bakeout for high reliability space programs.

- 1. Find the right modification code in the table below.
- 2. Add the "Mod Code" to the connector part number. Example: GHS4-M2L-2-9PA6J1-18MN-429C

SCREENING LEVEL AND AVAILABLE OUTGASSING MODIFICATION CODES

NASA Screening Level	Special Screening Only		Special Screening Plus Outgassing Processing		
		Face Seal Deleted (Plug Only)	48 Hour Oven Bake 125° C.	Thermal Vacuum Outgassing 24 hrs. 125° C.	
Level 1	Mod Code	Mod Code	Mod Code	Mod Code	
	429B	429F	429J	429C	
Level 2	Mod Code	Mod Code	Mod Code	Mod Code	
	429	429D	429K	429A	
Level 3	(Use Standard	Mod Code	Mod Code	Mod Code	
	Part Number)	432	186S	186M	

NASA SCREENING REQUIREMENTS (EEE-INST-002 TABLE 2C)

	NASA Screening Level		
Inspection/Test	Level 1 Highest Reliability	Level 2 High Reliability	
Visual Inspection	100% 10X magnification	100% 10X magnification	
Mechanical Inspection	2 connectors 10X magnification	2 connectors 10X magnification	
DWV/IR	2 connectors	2 connectors	
Contact Separation Force (Connectors with non-removable contacts)	2 connectors	Not required	
Mating and Unmating Force	2 connectors	Not required	
Hermeticity (Hermetic connectors only)	100%	100%	
Vacuum Bakeout (Optional, depends on Mod code)	100%	100%	

COMPONENT OUTGASSING PROPERTIES							
Component	Material	TML%	CVCM%	Test Reference			
VersaLink Insulator	GPS173	0.20	0.01	Glenair test at Pacific Testing Laboratories 7-19-2021			
MicroD Insulator	LCP	0.07	0.00	Glenair test at Pacific Testing Laboratories 7-25-2017			
Peripheral Seal	70/30 Fluorosilicone/ Silicone Blend*	0.12	0.02	Glenair test at Pacific Testing Laboratories 6-17-2020			
Rear Insulator (Right angle only)	PTFE	0.01	0.00	NASA Outgassing Data for Selecting Spacecraft Materials			
Organizer (Right angle only)	PPS	0.08	0.00	NASA Outgassing Data for Selecting Spacecraft Materials			
Ероху	Hysol EE-4215	0.55	<0.01	Glenair test at Pacific Testing Laboratories 7-25-2017			
Epoxy (Cable conn only)	Duralco 120	0.33	0.01	NASA Outgassing Data for Selecting Spacecraft Materials			

* Per GPS78 Grade 40

Rev. 11.08.24